

PCS3PS550A

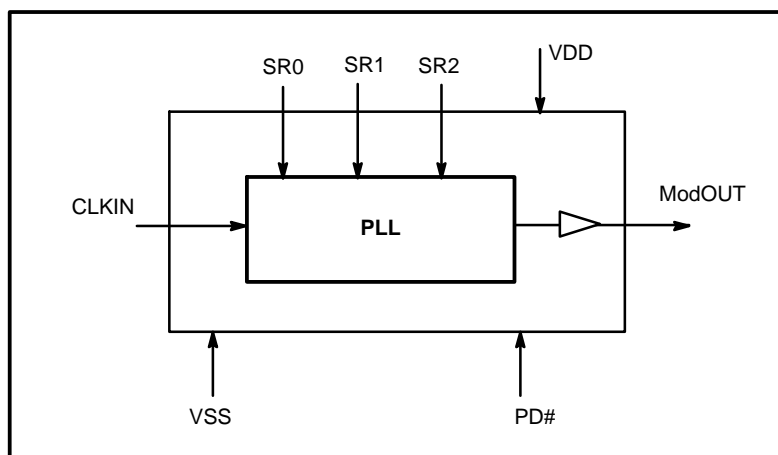


Figure 1. Block Diagram

PCS3PS550A modulates the output of a single PLL in order to “spread” the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal’s bandwidth is called ‘spread spectrum clock generation’.

PCS3PS550A accepts an input from an external reference clock and locks to a 1x modulated clock output. SR0, SR1 and SR2 pins enable selecting one of the eight different frequency deviations (Refer *Frequency Deviation Selection table*). PCS3PS550A also features power down option for power save. PCS3PS550A operates over a supply voltage range of 2.3 V to 3.6 V. PCS3PS550A is available in an 8 Pin WDFN, (2 mm x 2 mm) Package.

Table 1. PIN DESCRIPTION

Pin#	Pin Name	Type	Description
1	CLKIN	I	External reference clock input.
2	SR2	I	Digital logic input used to select Spreading Range. There is NO default state. Refer Frequency Deviation Selection Table.
3	PD#	I	Power-down control pin. Powers down the entire chip. There is NO default state. Pull low to enable power-down mode. Connect to VDD to disable Power Down. Output Clock will be LOW when power down is enabled
4	VSS	P	Ground connection.
5	ModOUT	O	Spread Spectrum Clock Output.
6	SR1	I	Digital logic input used to select Spreading Range. This pin has an internal pull-up resistor. Refer Modulation Selection Table.
7	SR0	I	Digital logic input used to select Spreading Range. There is NO default state. Refer Frequency Deviation Selection Table.
8	VDD	P	Power supply for the entire chip

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Table 2. FREQUENCY DEVIATION SELECTION TABLE

SR2	SR1	SR0	Spreading Range (±%) (@ 24 MHz)
0	0	0	1
0	0	1	2.5
0	1	0	1.25
0	1	1	1.5
1	0	0	0.4
1	0	1	0.75
1	1	0	1.75
1	1	1	2

Table 3. OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{DD}	Supply Voltage with respect to V _{SS}	2.3	3.6	V
T _A	Operating temperature	−20	+85	°C
C _L	Load Capacitance		15	pF
C _{IN}	Input Capacitance		7	pF

Table 4. ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Rating	Unit
V _{DD} , V _{IN}	Voltage on any input pin with respect to V _{SS}	−0.5 to +4.6	V
T _{STG}	Storage temperature	−65 to +125	°C
T _A	Operating temperature	−40 to +85	°C
T _s	Max. Soldering Temperature (10 sec)	260	°C
T _J	Junction Temperature	150	°C
T _{DV}	Static Discharge Voltage (As per JEDEC STD22–A114–B)	2	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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Table 5. DC ELECTRICAL CHARACTERISTICS

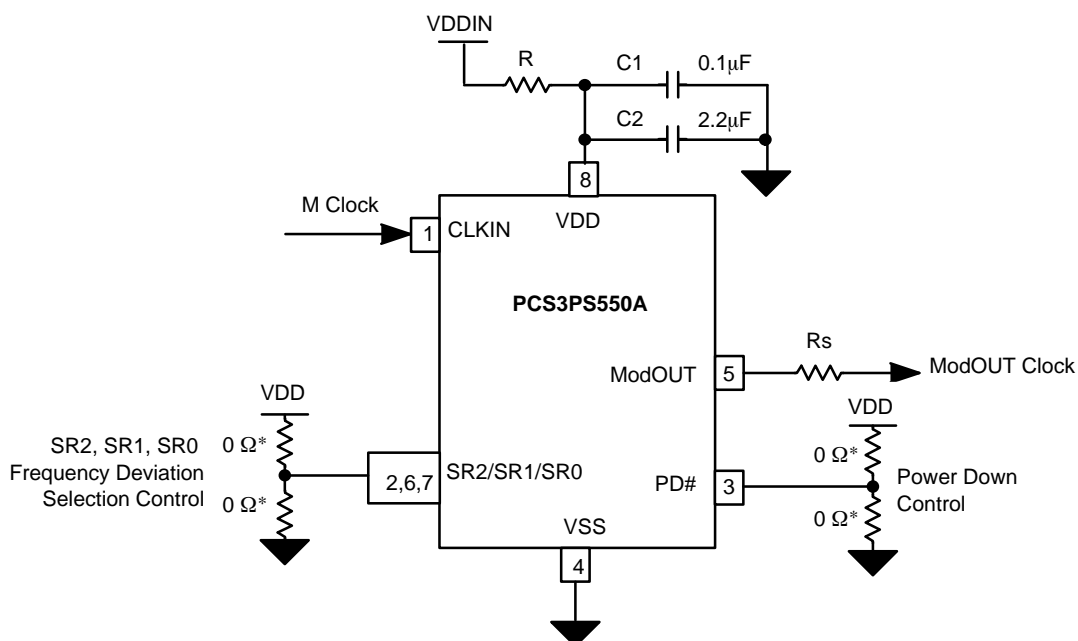
Symbol	Parameter	Min	Typ	Max	Unit
V _{DD}	Supply Voltage with respect to V _{SS}	2.3	2.8	3.6	V
V _{IH}	Input high voltage	0.65 * V _{DD}			V
V _{IL}	Input low voltage			0.3 * V _{DD}	V
I _{IH}	Input high current (SR1 control pin)			50	μA
I _{IL}	Input low current (SR1 control pin)			50	μA
V _{OH}	Output high voltage (I _{OH} = -8 mA)	0.75 * V _{DD}			V
V _{OL}	Output low voltage (I _{OL} = 8 mA)			0.2 * V _{DD}	V
I _{CC}	Static supply current (PD# pulled to V _{SS})			1	μA
I _{DD}	Dynamic supply current (Unloaded Output @ 24 MHz)		6	9	mA
Z _{OUT}	Output impedance		40		Ω

Table 6. AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Typ	Max	Unit
CLKIN	Input Clock frequency	18	24	40	MHz
ModOUT	Output Clock frequency	18	24	40	MHz
t _{LH} (Note 1)	Output rise time (Measured between 20% to 80%)	Unloaded Output	0.8	1.2	ns
		CL = 15 pF	2.4	3	
t _{HL} (Note 1)	Output fall time (Measured between 80% to 20%)	Unloaded Output	0.6	1	ns
		CL = 15 pF	1.9	2.8	
t _{JC} (Note 1)	Jitter (cycle to cycle) Unloaded Output		± 175	± 250	ps
t _D (Note 1)	Output duty cycle	45	50	55	%
t _{ON} (Note 1)	PLL lock Time (Stable power supply, valid clock presented on CLKIN pin, PD# toggled from Low to High)			3	ms
fd _{var}	Frequency Deviation Variation across PVT		± 2.5	± 5	%

1. Parameter is guaranteed by design and characterization. Not 100% tested in production

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NOTE: Refer Pin Description table for Functionality details.

*Choose the 0 Ohms resistor either to VDD or to VSS based on the logic state to be set for the control signal

Figure 2. Typical Application Schematic

PCB Layout Recommendation

For optimum device performance, following guidelines are recommended.

- Dedicated V_{DD} and V_{SS} (GND) planes.
- The device must be isolated from system power supply noise. A 0.1µF and a 2.2 µF decoupling capacitor should be mounted on the component side of the board as close to the VDD pin as possible. No vias should be used between the decoupling capacitor and VDD pin. The PCB trace to VDD pin and the ground via should be kept as short as possible. All the VDD pins should have decoupling capacitors.
- In an optimum layout all components are on the same side of the board, minimizing vias through other signal layers.

A typical layout is shown in the figure

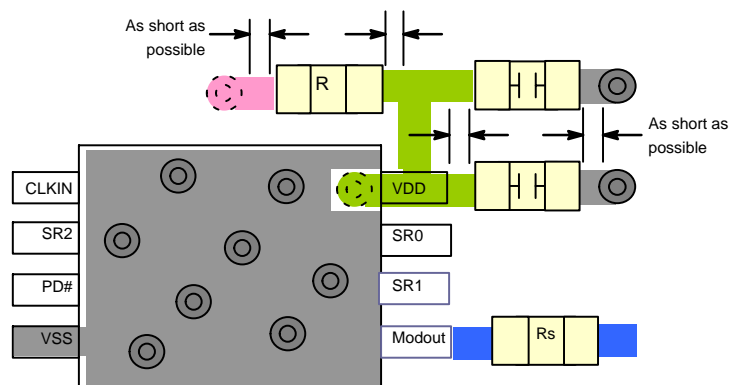


Figure 3.

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ORDERING INFORMATION

Part Number	Top Marking	Temperature	Package Type	Shipping†
PCS3PS550AG-08CR	CA	-20°C to +85°C	8L- WDFN (TDFN) (Pb-Free)	3000 / Tape & Reel

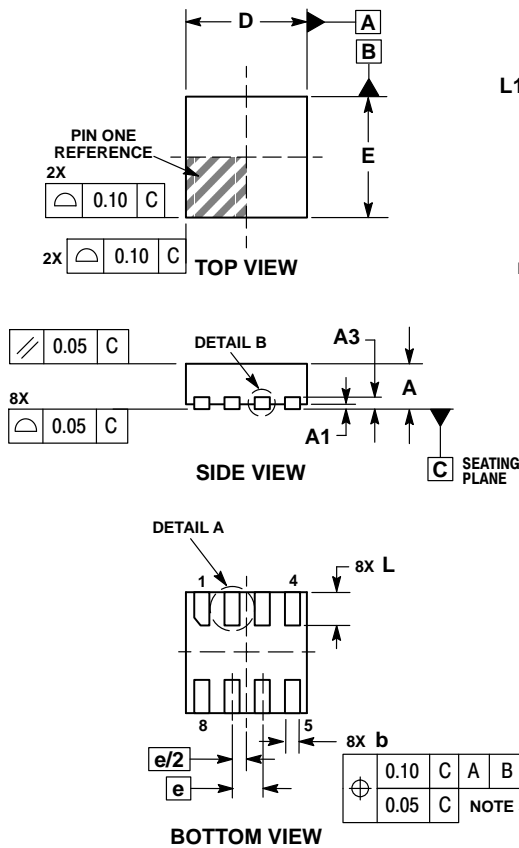
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*A “microdot” placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-Free.

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PACKAGE DIMENSIONS

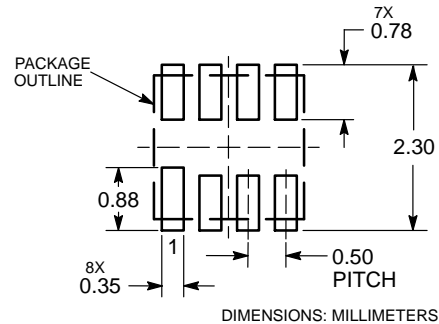
WDFN8 2x2, 0.5P
CASE 511AQ
ISSUE A



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL.

DIM	MILLIMETERS	
	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20 REF	
b	0.20	0.30
D	2.00 BSC	
E	2.00 BSC	
e	0.50 BSC	
L	0.50	0.60
L1	---	0.15

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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